

**ANISOTROPIC CRYSTALLITE  
SIZE ANALYSIS OF TEXTURED  
NANOCRYSTALLINE SILICON  
THIN FILMS PROBED BY  
X-RAY DIFFRACTION**

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# Introduction

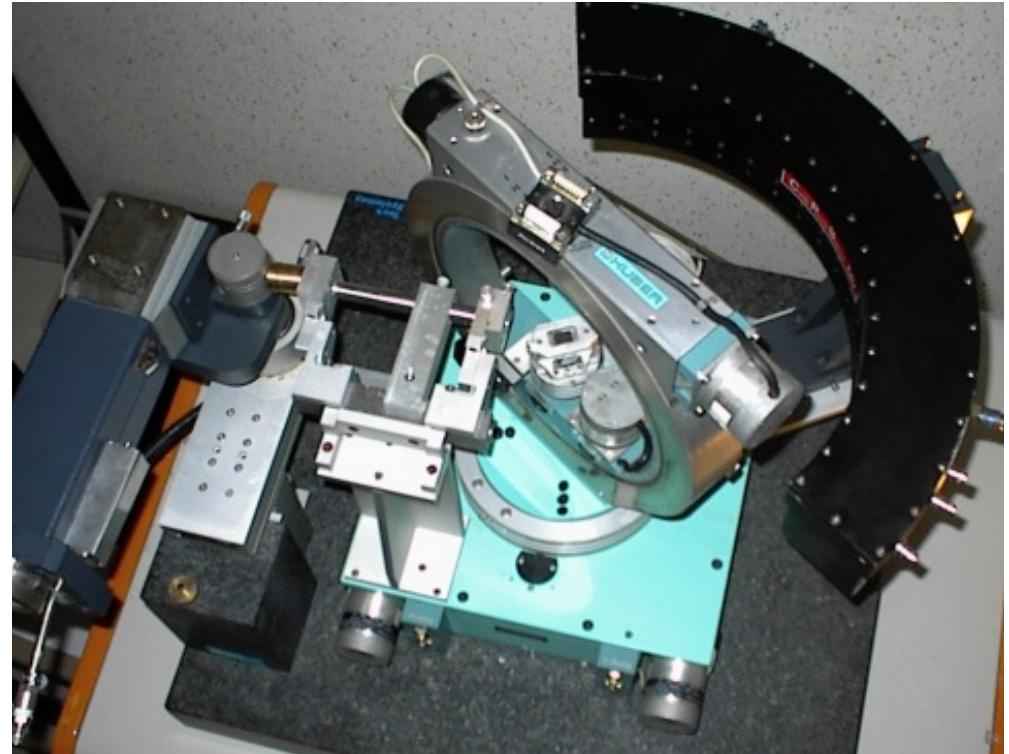
- ⇒ The new "combined" x-ray technique is used, which is able to characterise quantitatively:
  - texture
  - structure (cell parameters)
  - anisotropic crystallite shapes
  - film thickness
- ⇒ Samples are nanocrystalline silicon films, grown by reactive magnetron sputtering
- ⇒ Crystallographic results are correlated to refraction indexes and optical pseudo-gap

# X-rays experiments

**4 - circles  
diffractometer**

+

**Curved Position  
Sensitive Detector**



Cu K<sub>α</sub> radiation, Graphite monochromator, calibration: LaB<sub>6</sub>

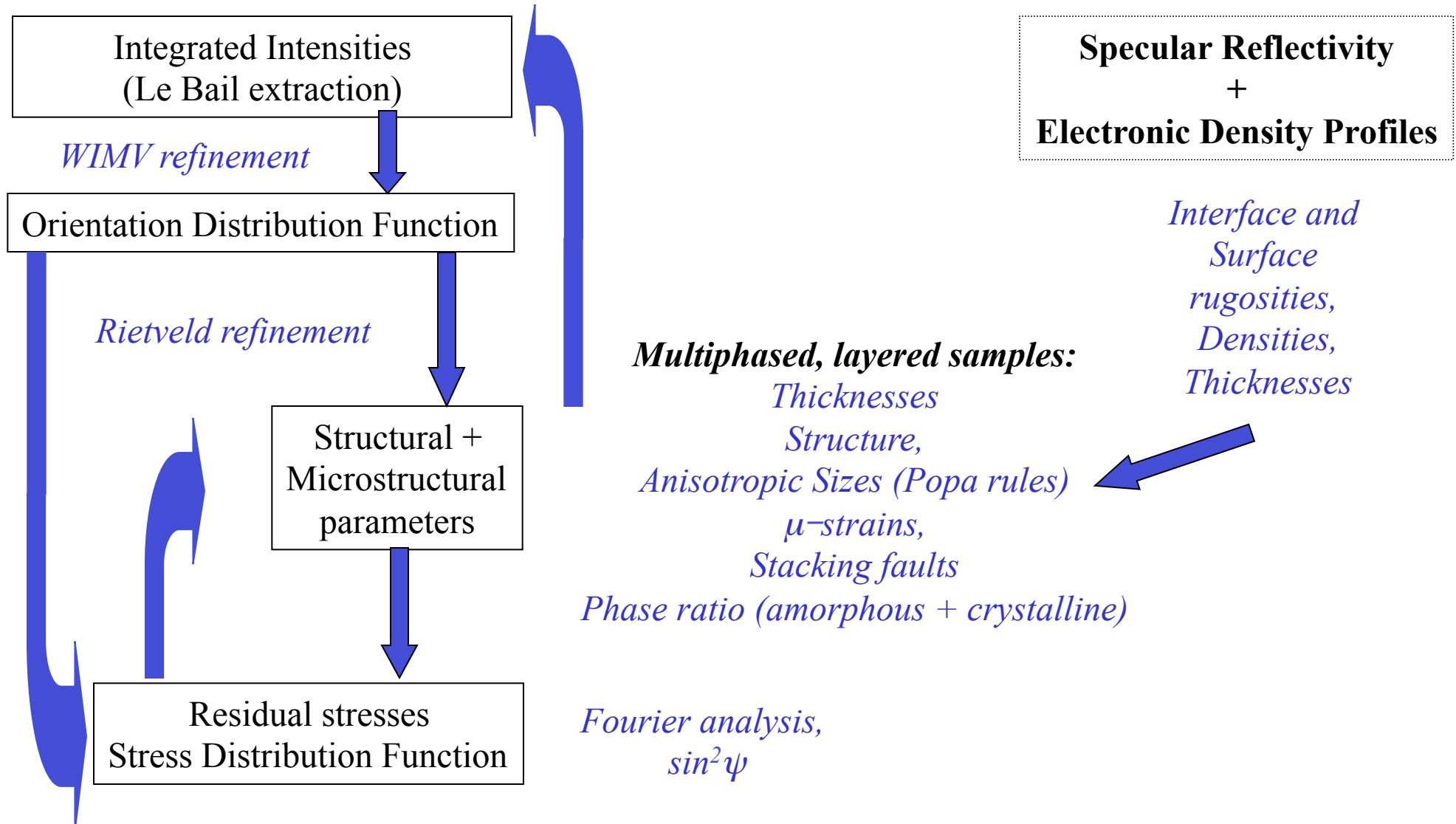
scans:  $\omega = 14.25^\circ$  (111 Si reflection),  $0 \leq \chi \leq 35^\circ$ ,  $\Delta\chi = 5^\circ$

# Samples

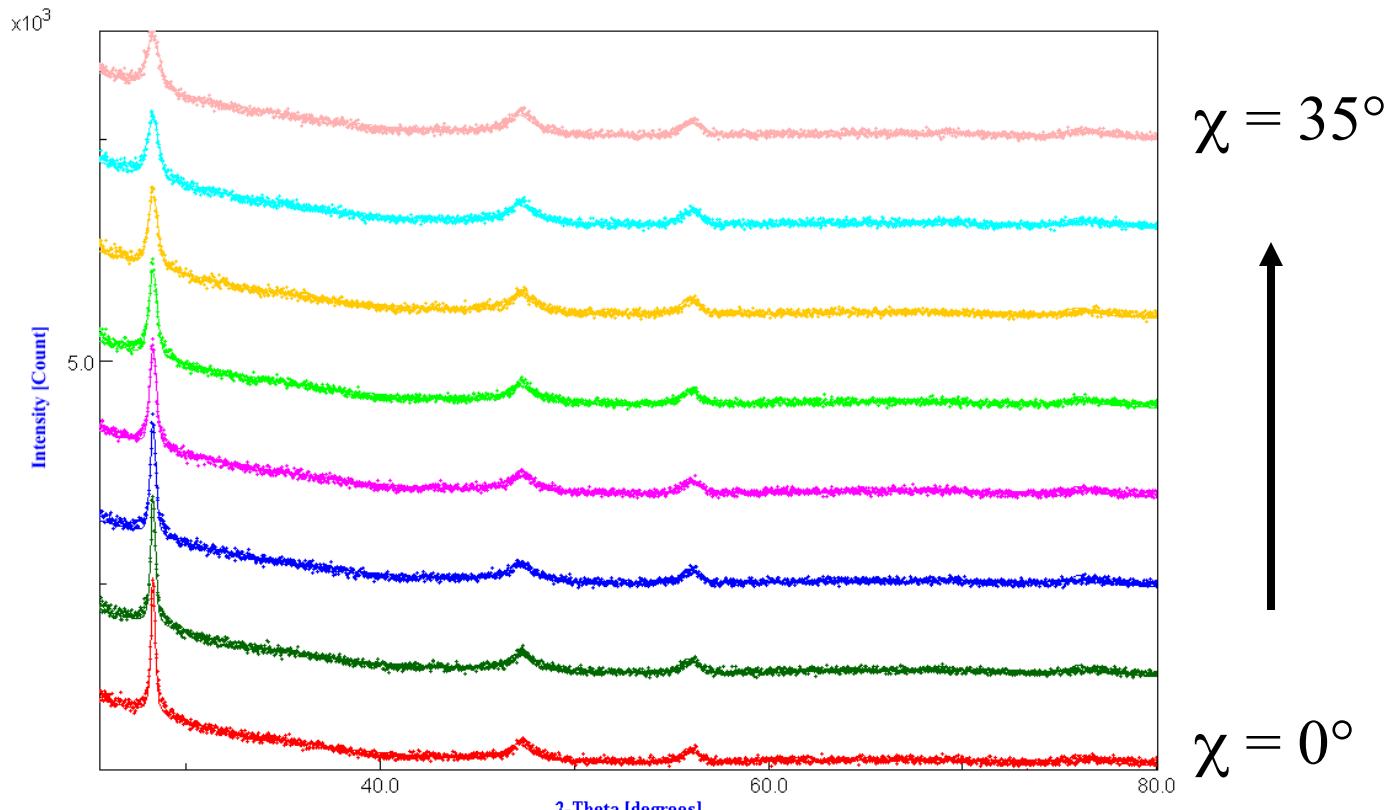
## Silicon thin films deposition by reactive magnetron sputtering:

- ↳ power density  $2\text{W/cm}^2$
- ↳ total pressure:  $p_{\text{total}} = 10^{-1}$  Torr
- ↳ plasma mixture:  $\text{H}_2 / \text{Ar}$ ,  $p\text{H}_2 / p_{\text{total}} = 80\%$
- ↳ temperature:  $200^\circ\text{C}$
- ↳ substrates: amorphous  $\text{SiO}_2$  (a- $\text{SiO}_2$ )  
(100)-Si single-crystals
- ↳ target-substrate distance (d)
  - a- $\text{SiO}_2$  substrates:  $d = 4, 6, 7, 8, 10, 12\text{ cm}$   
films A, B, C, D, E, F
  - (100)-Si:  $d = 6, 12\text{ cm}$   
films G, H

# Combined XRD analysis: MAUD



# Typical refinement



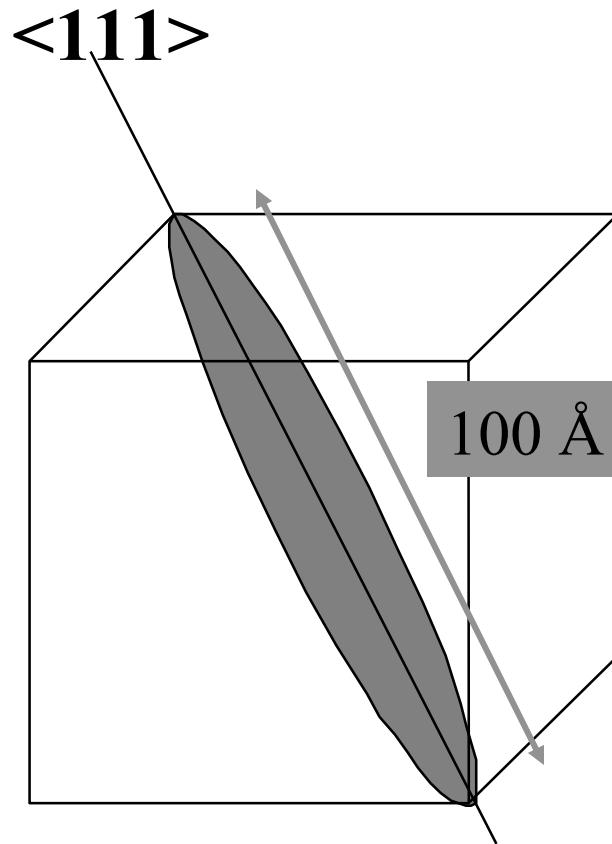
Silconyann7

Measured: dots, simulated: lines  
broad, anisotropic diffracted lines, textured samples

# Refinement Results

Sample	d (cm)	a (Å)	RX thickness (nm)	Anisotropic sizes (Å)			Texture parameters			Reliability factors (%)			
				<111>	<220>	<311>	Maximum (m.r.d.)	minimum (m.r.d.)	Texture index F <sup>2</sup> (m.r.d <sup>2</sup> )	RP <sub>0</sub>	R <sub>w</sub>	R <sub>B</sub>	R <sub>exp</sub>
A	4	5.4466 (3)	—	94	20	27	1.95	0.4	1.12	1.72	4.0	3.7	3.5
B	6	5.4439 (2)	711 (50)	101	20	22	1.39	0.79	1.01	0.71	4.9	4.3	4.2
C	7	5.4346 (4)	519 (60)	99	40	52	1.72	0.66	1.05	0.78	4.3	4.0	3.9
D	8	5.4461 (2)	1447 (66)	100	22	33	1.57	0.63	1.04	0.90	5.5	4.6	4.5
E	10	5.4462 (2)	1360 (80)	98	20	25	1.22	0.82	1.01	0.56	5.0	3.9	4.0
F	12	5.4452 (3)	1110 (57)	85	22	26	1.59	0.45	1.05	1.08	4.2	3.5	3.7
G	6	5.4387 (3)	1307 (50)	89	22	28	1.84	0.71	1.01	1.57	5.2	4.7	4.2
H	12	5.4434 (2)	1214 (18)	88	22	24	2.77	0.50	1.12	2.97	5.0	4.5	4.3

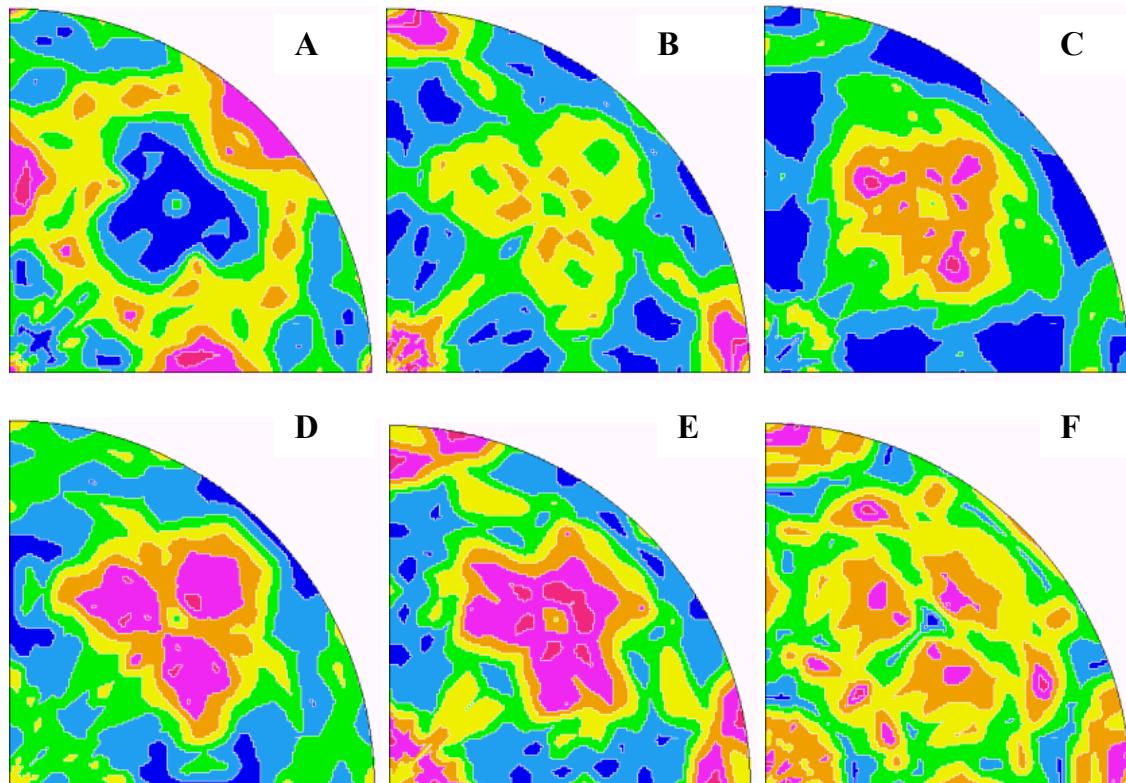
# Mean anisotropic shape



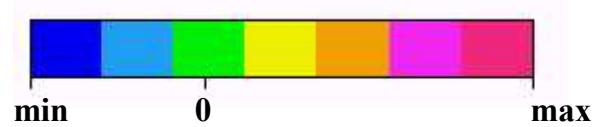
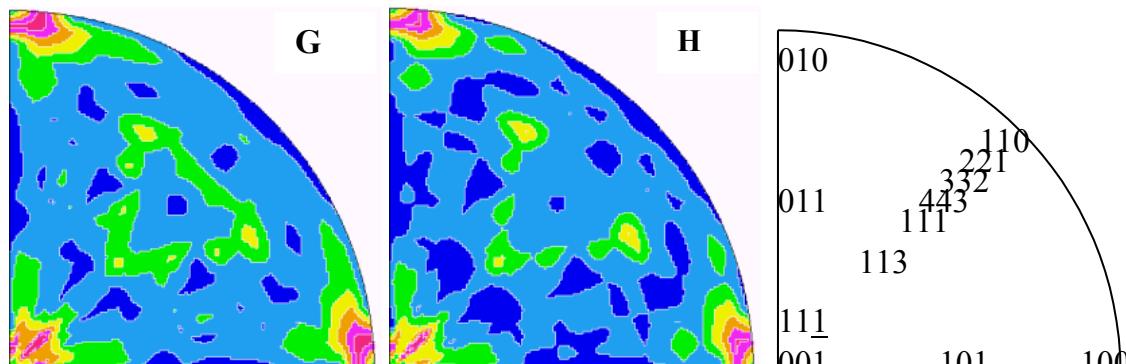
Schematic of the mean crystallite shape for Sample D represented in a cubic cell, as refined using the Popa approach and exhibiting a strong elongation along  $<111>$  (see Table).

# 001 Inverse Pole Figures

a-SiO<sub>2</sub>



(100)-Si



# Texture evolution with d

## Films on a-SiO<sub>2</sub> substrates:

- overall texture strength almost unaffected by d ( $F^2$  around 1.2 m.r.d.<sup>2</sup> at maximum), but texture components strongly influenced:
  - smallest distances (Sample A) favours <110> orientation with minor <100> and <124> components
  - <110> orientation is destabilised for larger d's
- <110> component removal accompanied by a slight tilt of <100> and the appearance of a large <221> like component
- progressive shift of <221> like component towards <111> for larger d's (Samples B to F)
- no pure <111> orientation is observed

## Films on (100)-Si substrates:

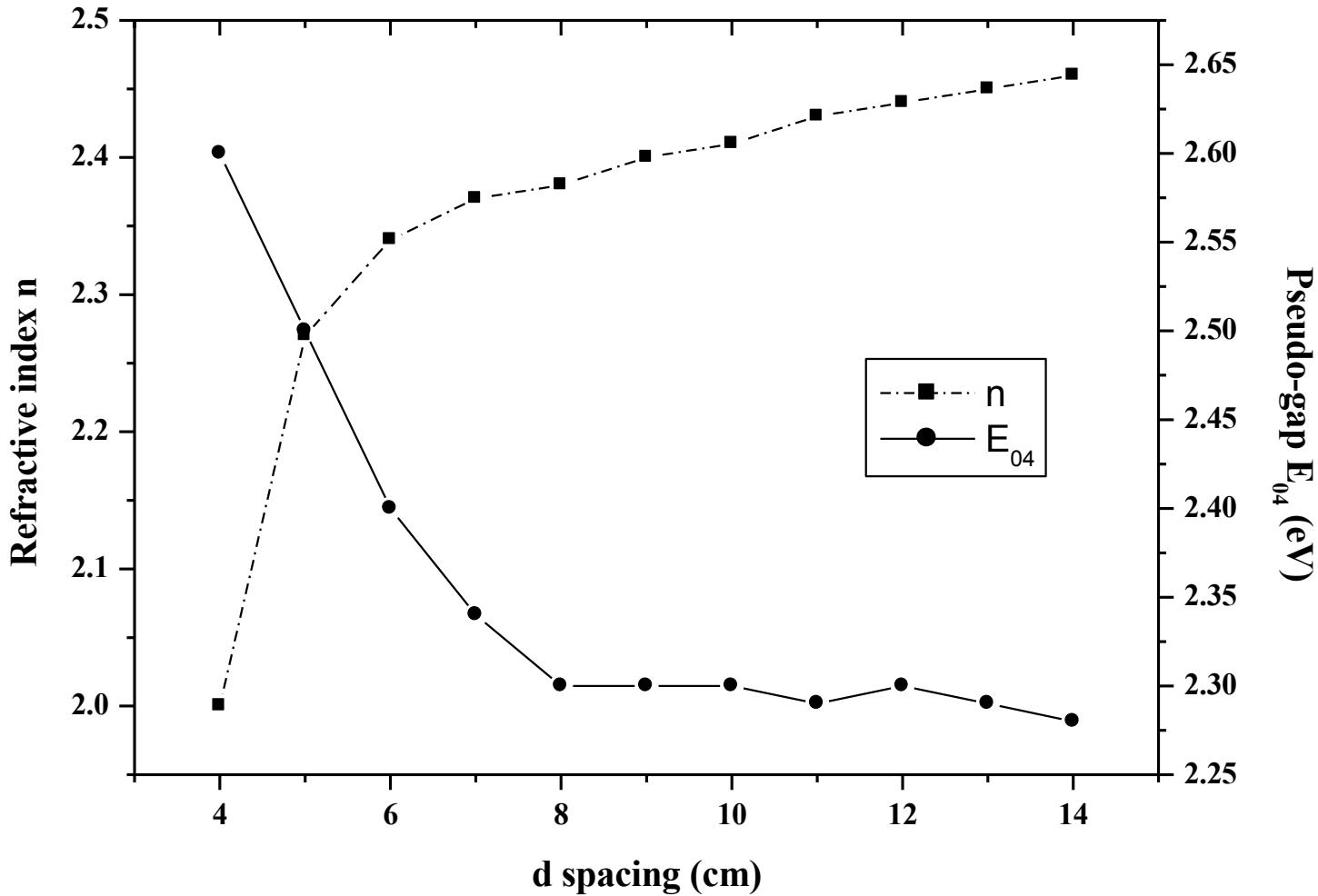
- stabilisation of single  $<100>$  component for all d's
  - heteroepitaxial growth:
    - [100]-film // [100]-substrate
    - native amorphous  $\text{SiO}_2$  layer etched by hydrogen species of the plasma
  - no  $<111>$  orientation is observed
- 
- $a_{\text{Si}}$  in films always larger than  $a_{\text{Si}}$  in bulk
  - ODF maxima larger using (100)-Si substrates

# Profilometry versus XRD thickness

Samples	d (cm)	Profilometry	RX thickness (nm)
		Thickness (nm)	
A	4	700	---
B	6	1350	711 (50)
C	7	1530	519 (60)
D	8	1465	1447 (66)
E	10	1470	1360 (80)
F	12	1208	1110 (57)
G	6	1350	1307 (50)
H	12	1200	1214 (18)

high porosity

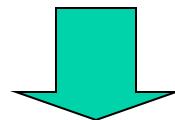
# Optical measurements: refractive indexes and pseudo-gap



# $\mu$ -structure versus optical properties

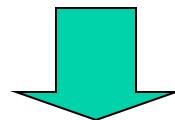
↳ large minimum ODF values: small anisotropy expected, 60 % to 20 % of textured volume

↳ abrupt increase of the refractive index (n) for small d's then saturation



reflects the film compactness

↳ opposite evolution of n and  $E_{04}$



relatively high density of microcavities inherent to the film porosity

# Conclusions

- Preferred orientations, cell parameters and anisotropic crystallite sizes of nanocrystalline silicon thin films deposited on a-SiO<sub>2</sub> and (100)-Si substrates have been quantitatively determined.
- Strong texture variations are observed when the electrode distance and/or the substrate is varied.
- Texture variations are correlated to the anisotropic crystal growth
- Porosities are correlated to refractive indices